

Dual Buffered Multiplying 8-Bit Digital-to-Analog Converter



FEATURES

- On-Chip Latches for Both DACs
- +5 V to +15 V Operation
- DACs Matched to 1%
- Four Quadrant Multiplication
- 15 V CMOS Compatible
- See MP7529A or MP7529B for Improved Performance

APPLICATIONS

- Microprocessor Controlled Gain Circuits
- Microprocessor Controlled Attenuator Circuits
- Microprocessor Controlled Function Generation
- Precision AGC Circuits
- Bus Structured Instruments

GENERAL DESCRIPTION

The MP7528 is a dual 8-bit digital/analog converter designed using EXAR's proven decoded DAC architecture. It features excellent DAC-to-DAC matching and guaranteed monotonicity.

Separate on-chip latches are provided for each DAC to allow easy microprocessor interface.

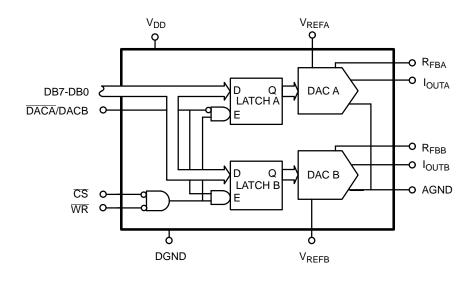
Data is transferred into either of the two DAC data latches via a common 8-bit TTL/CMOS compatible input port. Control input

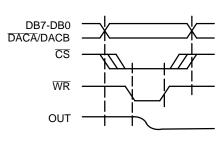
DACA/DACB determines which DAC is to be loaded. The MP7528's load cycle is similar to the write cycle of a random access memory and the device is bus compatible with most 8-bit microprocessors.

The device operates from a +5V to +15V power supply with only 2 mA of current (maximum).

Both DACs offer excellent four quadrant multiplication characteristics with a separate reference input and feedback resistor for each DAC.

SIMPLIFIED BLOCK AND TIMING DIAGRAM





T®M



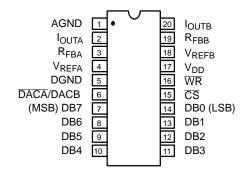
ORDERING INFORMATION

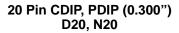
| Package Type | Temperature Range | Part No. | INL (LSB) | DNL (LSB) | Gain Error (LSB) |
|-----------------|----------------------|-----------|--------------|--------------|---------------------|
| Plastic Dip | –40 to +85°C | MP7528JN | <u>+</u> 1 | <u>+</u> 1 | <u>+</u> 6 |
| Plastic Dip | –40 to +85°C | MP7528KN | <u>+</u> 1/2 | <u>+</u> 1 | <u>+</u> 4 |
| Plastic Dip | –40 to +85°C | MP7528LN | <u>+</u> 1/4 | <u>+</u> 1 | <u>+</u> 3 |
| SOIC | –40 to +85°C | MP7528JS | <u>+</u> 1 | <u>+</u> 1 | <u>+</u> 6 |
| SOIC | –40 to +85°C | MP7528KS | <u>+</u> 1/2 | <u>+</u> 1 | <u>+</u> 4 |
| SOIC | –40 to +85°C | MP7528LS | <u>+</u> 1/4 | <u>+</u> 1 | <u>+</u> 3 |
| PLCC | –40 to +85°C | MP7528JP | <u>+</u> 1 | <u>+</u> 1 | <u>+</u> 6 |
| PLCC | -40 to +85°C | MP7528KP | <u>+</u> 1/2 | <u>+</u> 1 | <u>+</u> 4 |
| PLCC | –40 to +85°C | MP7528LP | <u>+</u> 1/4 | <u>+</u> 1 | <u>+</u> 3 |
| Ceramic Dip | -40 to +85°C | MP7528AD | <u>+</u> 1 | <u>+</u> 1 | <u>+</u> 6 |
| Ceramic Dip | –40 to +85°C | MP7528BD | <u>+</u> 1/2 | <u>+</u> 1 | <u>+</u> 4 |
| Ceramic Dip | –40 to +85°C | MP7528CD | <u>+</u> 1/4 | <u>+</u> 1 | <u>+</u> 3 |
| Ceramic Dip | −55 to +125°C | MP7528SD* | <u>+</u> 1 | <u>+</u> 1 | <u>+</u> 6 |
| Ceramic Dip | −55 to +125°C | MP7528TD* | <u>+</u> 1/2 | <u>+</u> 1 | <u>+</u> 4 |

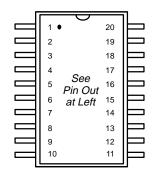
^{*}Contact factory for non-compliant military processing

PIN CONFIGURATIONS

See Packaging Section for Package Dimensions



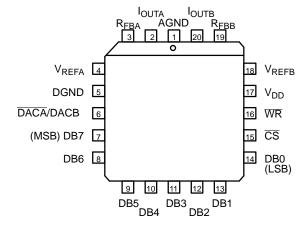




20 Pin SOIC (Jedec, 0.300") S20



PIN CONFIGURATIONS (CONT'D)



20 Pin PLCC P20

PIN OUT DEFINITIONS

| PIN NO. | NAME | DESCRIPTION | | | |
|---------|-------------------|-----------------------------|--|--|--|
| 1 | AGND | Analog Ground | | | |
| 2 | I _{OUTA} | Current Out DAC A | | | |
| 3 | R _{FBA} | Feedback Resistor for DAC A | | | |
| 4 | V_{REFA} | Reference Input for DAC A | | | |
| 5 | DGND | Digital Ground | | | |
| 6 | DAC A/ DAC B | DAC Select | | | |
| 7 | DB7 (MSB) | Data Input Bit 7 | | | |
| 8 | DB6 | Data Input Bit 6 | | | |
| 9 | DB5 | Data Input Bit 5 | | | |
| 10 | DB4 | Data Input Bit 4 | | | |
| 11 | DB3 | Data Input Bit 3 | | | |
| 12 | DB2 | Data Input Bit 2 | | | |
| 13 | DB1 | Data Input Bit 1 | | | |
| 14 | DB0 (LSB) | Data Input Bit 0 | | | |
| 15 | CS | Chip Select | | | |
| 16 | WR | Write | | | |
| 17 | V_{DD} | Power Supply | | | |
| 18 | V_{REFB} | Reference Input for DAC B | | | |
| 19 | R _{FBB} | Feedback Resistor for DAC B | | | |
| 20 | I _{OUTB} | Current Out DAC B | | | |



ELECTRICAL CHARACTERISTICS(VDD = + 5 V, VREF = +10 V unless otherwise noted)

| Parameter | Symbol | Min | 25°C Typ Max | Tmin to Min | o Tmax Max | Units | Test Conditions/Comments |
|---|---|--------|---------------------------------------|----------------|--------------------|------------------------------------|--|
| STATIC PERFORMANCE ¹ | | | | | | | |
| Resolution (All Grades) | N | 8 | | 8 | | | Bits |
| Integral Non-Linearity (Relative Accuracy) J, A, S K, B, T L, C | INL | | ±1 ±1/2 <u>±</u> 1/4 | | ±1 ±1/2 ±1/4 | LSB | End Point Linearity Spec. |
| Monotonicity | | | | | | | Guaranteed over temp |
| Differential Non-Linearity J, A, S K, B, T L, C | DNL | | <u>+</u> 1 | | <u>+</u> 1 | LSB | All grades monotonic over full temperature range. |
| Gain Error J, A, S K, B, T L, C | GE | | ±4 <u>+</u> 2 ±1 | | ±6 ±4 ±3 | LSB | Using Internal R _{FB} Digital Inputs = V _{INH} |
| Gain Temperature Coefficient ² | TC _{GE} | | | | <u>+</u> 70 | ppm/°C | Δ Gain/ Δ Temperature |
| Power Supply Rejection Ratio | PSRR | | <u>+</u> 200 | | <u>+</u> 400 | ppm/% | $ \Delta Gain/\Delta V_{DD} \Delta V_{DD} = \pm 5\%$ Digital Inputs = V_{INH} |
| Output Leakage Current (Pin 2) | I _{OUT1} | | <u>+</u> 50nA | | <u>+</u> 400nA | nA | Digital Inputs = V _{INL} |
| Output Leakage Current (Pin 20) | I _{OUT2} | | <u>+</u> 50nA | | <u>+</u> 400nA | nA | Digital Inputs = V _{INH} |
| Input Resistance | V _{REFA} V _{REFB} | 8 8 | 15 15 | 8 8 | 15 15 | kΩ kΩ | TC = -300 ppm/°C max. 11 kΩ typical |
| Input Resistance Matching | | | <u>+</u> 1 | | <u>+</u> 1 | % | |
| DYNAMIC PERFORMANCE ² | | | | | | | $R_L=100\Omega$, $C_L=13pF$ |
| Harmonic Distortion Digital Crosstalk Channel-to-Channel Isolation AC Feedthrough at I _{OUT1} Glitch Energy Propagation Delay | THD Q CCI FT EgI t _{PD} | | -85 30 -77 -70 160 220 | -65 270 | | dB nVs dB dB nVs ns | $V_{IN} = 6V_{RMS} \ @ 1 \ KHz$ Measured for code transition Z_S to F_{SS} $V_{REF} = 10 kHz, \ 20 \ V_P-p, sinewave$ Z_S to F_S Input Change From digital input to 90% of final analog output current |
| | | | | | | | |



ELECTRICAL CHARACTERISTICS (CONT'D)

| _ | | | 25°C | | o Tmax | | T . 0 . 1111 . 10 |
|---|--|---|------------------------|---|--------------------------------|--------------------------|--|
| Parameter | Symbol | Min | Тур Мах | Min | Max | Units | Test Conditions/Comments |
| DIGITAL INPUTS ³ | | | | | | | |
| Logical "1" Voltage Logical "0" Voltage Input Leakage Current Input Capacitance ² Data Control | V _{IH} V _{IL} I _{LKG} C _{IN} C _{IN} | 2.4 | 0.8 ±1 10 15 | 2.4 | 0.8 <u>+</u> 10 10 15 | V V μA pF pF | |
| ANALOG OUTPUTS ² | | | | | | | |
| Output Capacitance | C _{OUTA} C _{OUTA} C _{OUTB} C _{OUTB} | | 120 50 120 50 | | 120 50 120 50 | pF pF pF pF | DAC Inputs all 1's DAC Inputs all 0's DAC Inputs all 1's DAC Inputs all 0's |
| POWER SUPPLY ⁵ | | | | | | | |
| Functional Voltage Range ² Supply Current | V _{DD} I _{DD} | 4.5 | 15.75 2 2 | 4.5 | 15.75 2 2 | V mA mA | All digital inputs = 0 V or all = 5 V All digital inputs = V_{IL} or all = V_{IH} |
| SWITCHING CHARACTERISTICS ⁴ | | | | | | | |
| Chip Select to Write Set-Up Time Chip Select to Write Hold Time DAC Select to Write Set-Up Time DAC Select to Write Hold Time Data Valid to Write Set-Up Time Data Valid to Write Hold Time Write Pulse Width | tcs tch tas tah tds tdh twr | 200 20 200 20 110 0 180 | | 230 30 230 30 130 0 200 | | ns ns ns ns | |

NOTES:

- ¹ Full Scale Range (FSR) is 10V for unipolar mode.
- Guaranteed but not production tested.
- Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur.
- See timing diagram.
- 5 Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice





ELECTRICAL CHARACTERISTICS

 $(V_{DD} = + 15 \text{ V}, V_{REF} = +10 \text{ V} \text{ unless otherwise noted})$

| Parameter | Symbol | Min | 25°C Typ | Max | Tmin t Min | o Tmax Max | Units | Test Conditions/Comments |
|---|---|--------|--------------------------------|--|---------------|------------------------|------------------------------------|--|
| STATIC PERFORMANCE ¹ | | | | | | | | |
| Resolution (All Grades) | N | 8 | | | 8 | | | Bits |
| Integral Non-Linearity (Relative Accuracy) J, A, S K, B, T L, C | INL | | | <u>+</u> 1 <u>+</u> 1/2 <u>+</u> 1/4 | | ±1 ±1/2 ±1/4 | LSB | End Point Linearity Spec. |
| Monotonicity | | | | | | | | Guaranteed over temp |
| Differential Non-Linearity J, A, S K, B, T L, C | DNL | | | <u>+</u> 1 <u>+</u> 1 <u>+</u> 1 | | ±1 ±1 ±1 | LSB | All grades monotonic over full temperature range. |
| Gain Error J, A, S K, B, T L, C | GE | | | <u>+</u> 4 <u>+</u> 2 <u>+</u> 1 | | ±5 ±3 ±1 | LSB | Using Internal R _{FB} Digital Inputs = V _{INH} |
| Gain Temperature Coefficient ² | TC_GE | | | | | <u>+</u> 35 | ppm/°C | Δ Gain/ Δ Temperature |
| Power Supply Rejection Ratio | PSRR | | | <u>+</u> 100 | | <u>+</u> 200 | ppm/% | $ \Delta Gain/\Delta V_{DD} \Delta V_{DD} = \pm 5\%$ Digital Inputs = V_{INH} |
| Output Leakage Current (Pin 2) | I _{OUT1} | | : | <u>+</u> 50nA | | <u>+</u> 200nA | nA | Digital Inputs = V _{INL} |
| Output Leakage Current (Pin 20) | I _{OUT2} | | : | <u>+</u> 50nA | | <u>+</u> 200nA | nA | Digital Inputs = V _{INH} |
| Input Resistance | V _{REFA} V _{REFB} | 8 8 | | 15 15 | 8 8 | 15 15 | kΩ kΩ | TC = -300 ppm/°C max. 11 kΩ typical |
| Input Resistance Matching | | | | <u>+</u> 1 | | <u>+</u> 1 | % | |
| DYNAMIC PERFORMANCE ² | | | | | | | | R _L =100Ω, C _L =13pF |
| Harmonic Distortion Digital Crosstalk Channel-to-Channel Isolation AC Feedthrough at I _{OUT1} Glitch Energy Propagation Delay | THD Q CCI F _T Egl t _{PD} | | -85 60 -77 -70 440 | 80 | – 65 | 100 | dB nVs dB dB nVs ns | $\begin{split} &V_{IN}=6V_{RMS}\ @\ 1\ KHz\\ &Measured for code transition\\ &ZS\ to\ F_S\\ &V_{REF}=10kHz,\ 20\ Vp-p, sinewave\\ &ZS\ to\ F_S\ Input\ Change\\ &From\ 50\%\ of\ digital\ input\ to\ 90\%\\ &of\ final\ analog\ output\ current \end{split}$ |
| DIGITAL INPUTS ³ | | | | | | | | |
| Logical "1" Voltage Logical "0" Voltage Input Leakage Current Input Capacitance ² Data Control | V _{IH} V _{IL} I _{ILKG} C _{IN} C _{IN} | 13.5 | | 1.5 ±1 10 15 | 13.5 | 1.5 ±10 10 15 | V V μΑ pF pF | |



ELECTRICAL CHARACTERISTICS (CONT'D)

| Parameter | Symbol | Min | 25°C Typ Max | Tmin to Min | Tmax Max | Units | Test Conditions/Comments |
|--|---|---------------------------------|------------------------|---------------------------------------|------------------------|----------------------------------|--|
| ANALOG OUTPUTS ² | | | | | | | |
| Output Capacitance | C _{OUTA} C _{OUTA} C _{OUTB} C _{OUTB} | | 120 50 120 50 | | 120 50 120 50 | pF pF pF pF | DAC Inputs all 1's DAC Inputs all 0's DAC Inputs all 1's DAC Inputs all 0's |
| POWER SUPPLY ⁵ Functional Voltage Range ² Supply Current | V _{DD} | 4.5 | 15.75 2 2 | 4.5 | 15.75 2 2 | V mA mA | All digital inputs = 0 V or all = 5 V All digital inputs = V_{IL} or all = V_{IH} |
| SWITCHING CHARACTERISTICS Chip Select to Write Set-Up Time Chip Select to Write Hold Time DAC Select to Write Set-Up Time DAC Select to Write Hold Time Data Valid to Write Set-Up Time Data Valid to Write Hold Time Write Pulse Width | tcs tch tas tah tos toh | 60 10 60 10 30 0 | | 80 15 80 15 40 0 80 | | ns ns ns ns ns ns | |

NOTES:

- ¹ Full Scale Range (FSR) is 10V for unipolar mode.
- ² Guaranteed but not production tested.
- Digital input levels should not go below ground or exceed the positive supply voltage, otherwise damage may occur.
- See timing diagram.
- Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)^{1, 2, 3}

| V _{DD} to GND+17 V | V _{RFBA} , V _{RFBB} to GND |
|--|---|
| AGND to DGND | Storage Temperature65°C to +150°C |
| (Functionality Guaranteed ±0.5 V) | Lead Temperature (Soldering, 10 secs.) +300°C |
| Digital Input Voltage to DGND0.5 V, +17 V | Package Power Dissipation Rating to 75°C |
| V_{PIN2} , V_{PIN20} to GND | CDIP, PDIP, SOIC, PLCC 900mW |
| V _{REFA} , V _{REFB} to GND | Derates above 75°C 12mW/°C |

NOTES:

- Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies.
- 3 GND refers to AGND and DGND.

Rev. 2.00





INTERFACE LOGIC INFORMATION

DAC Selection: Both DAC latches share a common 8-bit input port. The control input DACA/DACB selects which DAC can accept data from the input port.

Mode Selection: Inputs $\overline{\text{CS}}$ and $\overline{\text{WR}}$ control the operating mode of the selected DAC. See Mode Selection Table below:

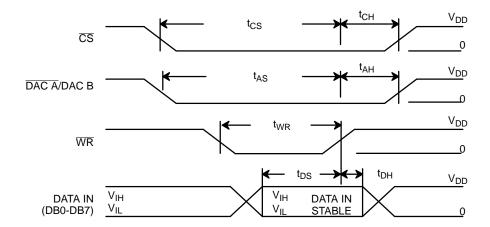
Write Mode: When \overline{CS} and \overline{WR} are both low the selected DAC is in the write mode. The input data latches of the selected DAC are transparent and its analog output responds to activity on DB0-DB7.

Hold Mode: The selected DAC latch retains the data which was present on DB0-DB7 just prior to \overline{CS} and \overline{WR} assuming a high state. Both analog outputs remain at the values corresponding to the data in their respective latches.

| DAC A/DAC B | CS | WR | DAC A | DAC B |
|-------------|----|----|-------|-------|
| L | L | L | Write | Hold |
| H | L | L | Hold | Write |
| X | H | X | Hold | Hold |
| X | X | H | Hold | Hold |

L = LOW state, H = HIGH state, X = Don't care state

Table 1. Mode Selection Table



NOTES:

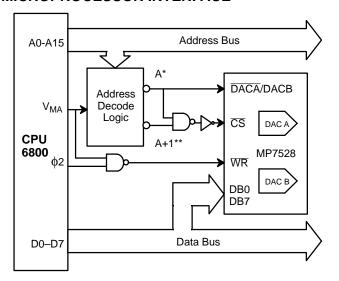
- 1. All input signal rise and fall times measured from 10% to 90% of V_{DD} . V_{DD} = +5 V, t_r = t_f = 20 ns V_{DD} = +15 V, t_r = t_f = 40 ns
- 2. Timing measurement reference level is $V_{IH} + V_{IL} / 2$

Figure 1. Write Cycle Timing Diagram



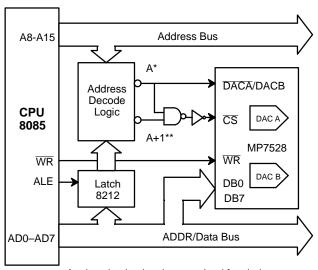


MICROPROCESSOR INTERFACE



Analog circuitry has been omitted for clarity *A = Decoded 7528 DAC A Address **A + 1 = Decoded 7528 DAC B Address

Figure 2. MP7528 Dual DAC to 6800 CPU Interface



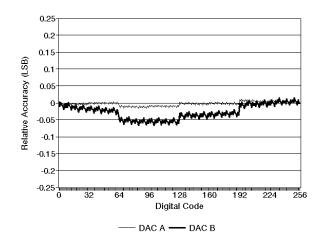
Analog circuitry has been omitted for clarity *A = Decoded 7528 DAC A Address **A + 1 = Decoded 7528 DAC B Address

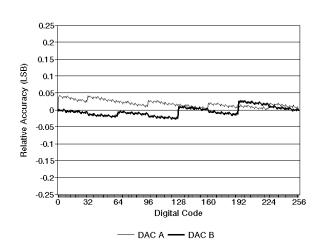
NOTE:

8085 instruction SHLD (store H & L direct) can update both DACS with data from H and L registers

Figure 3. MP7528 Dual DAC to 8085 CPU Interface

PERFORMANCE CHARACTERISTICS





Graph 1. Relative Accuracy vs. Digital Code 5 V

Graph 2. Relative Accuracy vs. Digital Code 15 V

T@M

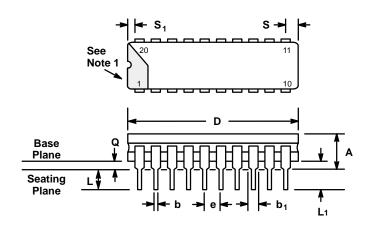


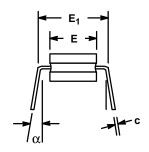
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20 LEAD CERAMIC DUAL-IN-LINE (300 MIL CDIP) D20





| | INCHES | | MILLIN | | |
|----------------|--------|--------|--------|-------|-------|
| SYMBOL | MIN | MAX | MIN | MAX | NOTES |
| А | _ | 0.200 | | 5.08 | |
| b | 0.014 | 0.023 | 0.356 | 0.584 | _ |
| b ₁ | 0.038 | 0.065 | 0.965 | 1.65 | 2 |
| С | 0.008 | 0.015 | 0.203 | 0.381 | _ |
| D | _ | 1.060 | | 26.92 | 4 |
| Е | 0.220 | 0.310 | 5.59 | 7.87 | 4 |
| E ₁ | 0.290 | 0.320 | 7.37 | 8.13 | 7 |
| е | 0.10 | 00 BSC | 2.5 | 5 | |
| L | 0.125 | 0.200 | 3.18 | 5.08 | _ |
| L ₁ | 0.150 | _ | 3.81 | _ | _ |
| Q | 0.015 | 0.070 | 0.381 | 1.78 | 3 |
| S | _ | 0.080 | _ | 2.03 | 6 |
| S ₁ | 0.005 | _ | 0.13 | _ | 6 |
| α | 0° | 15° | 0° | 15° | _ |

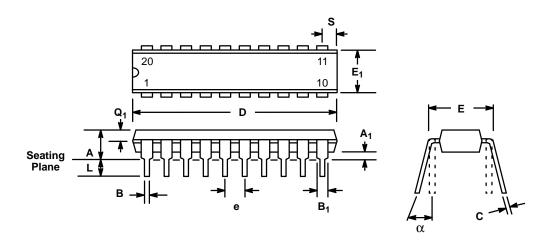
NOTES

- Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
- $\begin{array}{ll} \hbox{2.} & \hbox{The minimum limit for dimension b_1 may be 0.023} \\ & \hbox{(0.58 mm) for all four corner leads only.} \end{array}$
- 3. Dimension Q shall be measured from the seating plane to the base plane.
- 4. This dimension allows for off-center lid, meniscus and glass overrun.
- The basic lead spacing is 0.100 inch (2.54 mm) between centerlines.
- 6. Applies to all four corners.
- 7. This is measured to outside of lead, not center.





20 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP) N20



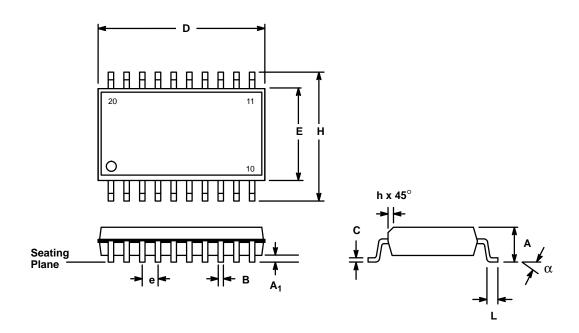
| | INC | HES | MILLIN | METERS |
|--------------------|-------|--------|--------|--------|
| SYMBOL | MIN | MAX | MIN | MAX |
| Α | | 0.200 | | 5.08 |
| A ₁ | 0.015 | _ | 0.38 | _ |
| В | 0.014 | 0.023 | 0.356 | 0.584 |
| B ₁ (1) | 0.038 | 0.065 | 0.965 | 1.65 |
| С | 0.008 | 0.015 | 0.203 | 0.381 |
| D | 0.945 | 1.060 | 24.0 | 26.92 |
| Е | 0.295 | 0.325 | 7.49 | 8.26 |
| E ₁ | 0.220 | 0.310 | 5.59 | 7.87 |
| е | 0.10 | 00 BSC | 2.5 | 4 BSC |
| L | 0.115 | 0.150 | 2.92 | 3.81 |
| α | 0° | 15° | 0° | 15° |
| Q ₁ | 0.055 | 0.070 | 1.40 | 1.78 |
| S | 0.040 | 0.080 | 1.02 | 2.03 |

Note: (1) The minimum limit for dimensions B1 may be 0.023" (0.58 mm) for all four corner leads only.





20 LEAD SMALL OUTLINE (300 MIL JEDEC SOIC) S20



| | INC | CHES | MILLIN | METERS | |
|----------------|--------|--------|----------|--------|--|
| SYMBOL | MIN | MAX | MIN | MAX | |
| А | 0.097 | 0.104 | 2.464 | 2.642 | |
| A ₁ | 0.0050 | 0.0115 | 0.127 | 0.292 | |
| В | 0.014 | 0.019 | 0.356 | 0.483 | |
| С | 0.0091 | 0.0125 | 0.231 | 0.318 | |
| D | 0.500 | 0.510 | 12.70 | 12.95 | |
| E | 0.292 | 0.299 | 7.42 | 7.59 | |
| е | 0.0 | 50 BSC | 1.27 BSC | | |
| Н | 0.400 | 0.410 | 10.16 | 10.41 | |
| h | 0.010 | 0.016 | 0.254 | 0.406 | |
| L | 0.016 | 0.035 | 0.406 | 0.889 | |
| α | 0° | 8° | 0° | 8° | |



Notes





Notes





NOTICE

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